RCO – RP400xxx1B SERIES

HIGH EFFICIENCY, SMALL PACKAGES, STEP-UP DC/DC CONVERTERS

NO.EA-193-150909

OUTLINE

RP400xxx1B Series are high efficiency, step-up DC/DC converter ICs packaged in compact 5pin SOT23 or 6pin DFN(PLP). This converter starts up of low voltage (Typ.0.7V) operation from one to two alkaline or a nickel-metal-hydride (NiMH) or one-cell Lithium-ion (Li+) battery.

This IC consists of a reference voltage unit with soft start, an error amplifier, phase compensation circuits, a slope circuit, a PWM control circuit, a start-up circuit, a PWM/VFM mode control circuit, internal switches and a protection circuit. As a protection circuit, RP400xxx1B has a current limit circuit which limits the peak current of the inductor at each clock cycle.

A low ripple high efficiency step up DC/DC converter can be composed of RP400xxx1B Series with only an inductor, a diode and capacitors. This converter is based on a fixed frequency current mode PWM control which goes to power save mode (VFM mode) at light load automatically. RP400xxx1B Series has built-in Anti-ringing switch to prevent switching node from ringing, when the converter enters the discontinuous current mode.

The output voltage of RP400K001B can be set within 1.8~5.0V (recommended range of output voltage) by external divider resistors.

FEATURES

- Low Start-up Voltage guaranteed0.7V
- Input Voltage Range ······0.7V ~ 5.5V

- Internal Switch.....NMOS = 0.4Ω (V_{OUT} = 3.3V, 25°C)
- Built-in Phase Compensation, Soft Start, Peak Current Limit Protection
- PWM Oscillator Frequency......700kHz
- Output Voltage Range Fixed: 1.8V to 5.0V with 0.1V Stepwise

Adjustable: 1.8V ~ 5.0V (RP400K001B only)

(Recommended range of output voltage)

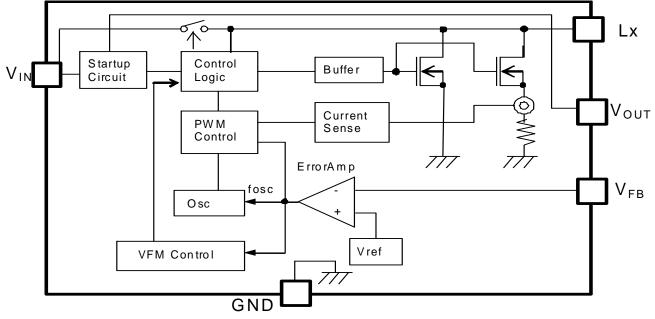
- Stable with Ceramic Capacitors
- Small PackageDFN(PLP)1820-6, SOT-23-5
- Internal EMI suppression (Anti-ringing switch is included)

APPLICATIONS

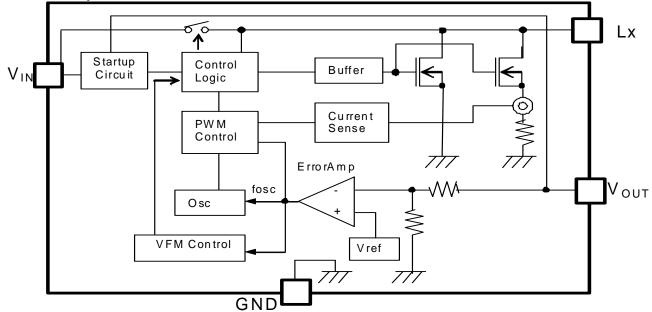
- MP3 players, PDA
- Digital Still Cameras
- LCD Bias Supplies
- Portable blood pressure meter
- Wireless Handset
- GPS

BLOCK DIAGRAMS

1. Adjustable Output: RP400K001B



2. Fixed Output: RP400xxx1B



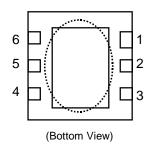
SELECTION GUIDE

In the RP400 Series, output Voltage, Type of Output Voltage, and package for the ICs can be selected at the user's request.

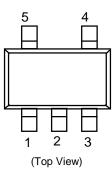
Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP400Kxx1B-TR	DFN (PLP)1820-6	5,000 pcs	Yes	Yes
RP400Nxx1B-TR-FE	SOT-23-5 3,000 pcs Yes Yes		Yes	
xx : Designation of our 00: Adjustable Ve Fixed version is p	rsion (1.8V ~ 5.0V) * re	commended range of outp m 1.8V to 5.0V with a s	ut voltage / DFN(PLP)18 step of 0.1V	20-6 only

PIN CONFIGURATION

DFN(PLP)1820-6



SOT-23-5



PIN DESCRIPTION

RP400K001B: DFN(PLP)1820-6

Pin No	Symbol	Pin Description
1	Vin	Power Supply Pin
2	NC	No Connection
3	GND	Ground Pin
4	Lx	Internal NMOS Switch Drain Pin
5	V _{FB}	Feedback Input Pin for setting output voltage
6	Vout	Output Pin

* Tab is GND level. (They are connected to the reverse side of this IC.) The tab is better to be connected to the GND, but leaving it open is also acceptable.

RP400Kxx1B: DFN(PLP)1820-6

Pin No	Symbol	Pin Description
1	Vin	Power Supply Pin
2	NC	No Connection
3	GND	Ground Pin
4	Lx	Internal NMOS Switch Drain Pin
5	NC	No Connection
6	Vout	Output Pin

* Tab is GND level. (They are connected to the reverse side of this IC.) The tab is better to be connected to the GND, but leaving it open is also acceptable.

RP400Nxx1B: SOT-23-5

Pin No	Symbol	Pin Description
1	NC	No Connection
2	GND	Ground Pin
3	V _{IN}	Power Supply Pin
4	Vout	Output Pin
5	Lx	Internal NMOS Switch Drain Pin

ABSOLUTE MAXIMAM RATINGS

				(GND=0V
Symbol	Items	Rat	ings	Unit
Vin	V _{IN} Supply Voltage	-0.3 1	to 6.0	V
Vout	Vout Pin Voltage	-0.3 1	to 6.0	V
V _{LX}	Lx Pin Input Voltage	-0.3 1	to 6.0	V
V _{FB}	V _{FB} Pin Voltage	RP400K001B	-0.3 to 6.0	V
I _{LX}	Lx Pin Output Current	0	.8	А
Р	Davian Diagin ation *	SOT-23-5	420	
PD	Power Dissipation *	DFN(PLP)1820-6	880	— mW
Та	Ambient Temp Range	-40 to	o + 85	°C
Tstg	Storage Temp Range	-55 to	+ 125	°C

*) For Power Dissipation, please refer to PACKAGE INFORMATION.

ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause the permanent damages and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings is not assured.

RECOMMENDED OPERATING CONDITIONS (ELECTRICAL CHARACTERISTICS)

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if when they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

ELECTRICAL CHARACTERISTICS

	1	1		1	1	(Ta	=25°C)
Symbol	Item	Conditions		MIN.	TYP.	MAX.	Unit
Vin	Input Voltage					5.5	V
Vstart ₁	Start-up Voltage 1	Load current =1mA			0.7	0.9	V
Vhold ₁	Hold-on Voltage 1 (Once started)	Load current=1mA		0.7			V
IDD1 Quiescent Current 1	Adjustable Version	V _{IN} =3V V _{OUT} =5V V _{FB} =0V		500	800	μA	
		Fixed Version.	V _{IN} =0.5×V _{OUT} V _{OUT} = 0.95×V _{OUT}		V _{ОUT} ×100	(*3)	μA
I _{DD2}	Quiescent Current 2	Adjustable Version	V _{IN} =V _{OUT} =5V V _{FB} =1.0V		160	300	μA
	(No switching)	Fixed Version	VIN=VOUT=5V		160	300	μA
VFB	Feedback Voltage (Adjustable Version)	VIN=VOUT=3.3V		0.588	0.600	0.612	V
Vout	Output-Voltage (Fixed Version)	V _{IN} = 1.5V		×0.98		×1.02	V
ΔV _{OUT} /ΔTa	Output-Voltage Temperature Coefficient	-40°C≤Ta≤85°C			±100		ppm /°C
faaa	fosc Switching Frequency	Adjustable Version	V _{IN} =V _{OUT} =3.3V	595	700	805	kHz
IOSC		Fixed Version.	VIN=VOUT=0.95×VOUT	595	700	805	kHz
∆fosc /∆Ta	Switching Frequency Temperature Coefficient	-40°C≤Ta≤85°C			±0.2		kHz ∕°C
Ronn	NMOS On-Resistance (*1)	V _{OUT} =3.3V			0.4		Ω
I _{FBH}	FB "H" Input Current (Adjustable Version)	VIN=VOUT=VFB=5V	VIN=VOUT=VFB=5V			0.5	μA
I _{XFBL}	FB "L" Input Current (Adjustable Version)	V _{IN} =V _{OUT} =5V V _{FB} =0V		-0.5			μA
ь.	Ly Look Current limit (*0)	Adjustable Version	V _{OUT} =3.3V Detective at Duty=MaxDuty-5%	0.4	0.6		A
I _{Lxpeak} Lx Leak Current limit (Lx Leak Current limit (^2)	Fixed Version.	V _{OUT} = 0.95×V _{OUT} Detective at Duty=MaxDuty-5%	0.4	0.6		A

ELECTRICAL CHARACTERISTICS (cont.)

			-			(Ta	=25°C)
Symbol	Item	Conditions		MIN.	TYP.	MAX.	Unit
Maxduty Max Duty	Max Dutv	Adjustable Version	V _{IN} =V _{OUT} =3.3V V _{FB} =0V	80	88	95	%
	,	Fixed Version.	VIN=VOUT=0.95×VOUT	80	88	95	%
tstart Soft St	Soft Start period	Adjustable Version	V _{IN} =0V to 1.65V V _{OUT} =3.3V At V _{OUT} =2.97V	0.08	0.7	3.0	ms
		Fixed Version.	V_{IN} = 0V to $V_{OUT} \times 0.5$ At V_{OUT} = $V_{OUT} \times 0.9$	0.08	0.7	3.0	ms
Rona	Anti-ringing switch	Adjustable Version	VIN=VOUT=3.3V		110		Ω
	KONA	On Resistance	Fixed Version.	Vin=Vout=1.05×Vout		110	

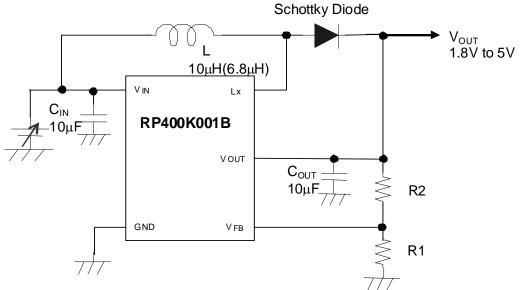
*1) Guaranteed by design engineering. NMOS On-Resistance according to the V_{OUT} voltage.
*2) Lx limit current changes by Duty.
*3) The maximum value of Operating Current 1(Fixed Version) is shown on the table below.

Vout (V)	ΜΑΧ (μΑ)
1.8 V	290
1.9 V	310
2.0 V	320
2.1 V	340
2.2 V	360
2.3 V	370
2.4 V	390
2.5 V	400
2.6 V	420
2.7 V	440
2.8 V	450
2.9 V	470
3.0 V	480
3.1 V	500
3.2 V	520
3.3 V	530
3.4 V	550

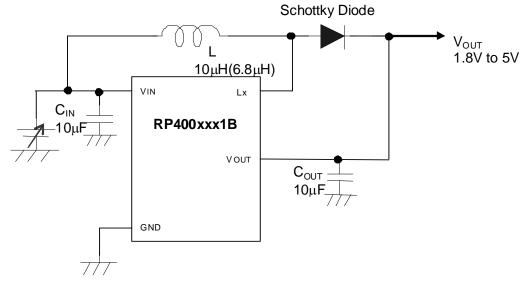
Vout (V)	ΜΑΧ (μΑ)
3.5 V	560
3.6 V	580
3.7 V	600
3.8 V	610
3.9 V	630
4.0 V	640
4.1 V	660
4.2 V	680
4.3 V	690
4.4 V	710
4.5 V	720
4.6 V	740
4.7 V	760
4.8 V	770
4.9 V	790
5.0 V	800

APPLICATION NOTES

Adjustable Output Voltage Type (Version:B)



Fixed Output Voltage Type (Version:B)



External components

Capacitor	: C2012JB1C106M (TDK)
Diode	: CRS10I30A (TOSHIBA)
Inductor	: TDK SLF7045T-100M1R3-PF(TDK)

Setting of Output Voltage

Output voltage (1.8V to 5.0V recommended range of voltage) can be set with divider resistors for voltage setting, R1 and R2 as shown in the typical application. Refer to the next formula.

 $\begin{array}{ll} \mbox{Output Voltage} = V_{FB} \times (R1 + R2) \mbox{ / } R1 & (V_{FB} = 0.6V) \\ \mbox{Recommended value of resistors } (R1 + R2) \mbox{ is lower than } 100 \mbox{ } \Omega. \end{array}$

Make sufficient power supply and ground and reinforce supplying. The large switching current could flow through the connection of power supply, inductor, ground, diode and the connection of V_{OUT} . If the impedance of the connection of power supply and ground is high, the voltage level of power supply of the IC fluctuates with the switching current. We recommend you to use output capacitor and diode with an allowable voltage at least 1.5 times as much as setting output voltage. This is because there may be case where a spike-shaped high voltage is generated by an inductor when built-in transistor is on and off.

Use a diode of a Schottky type with high switching speed, low reverse current and also pay attention to its current capacity.

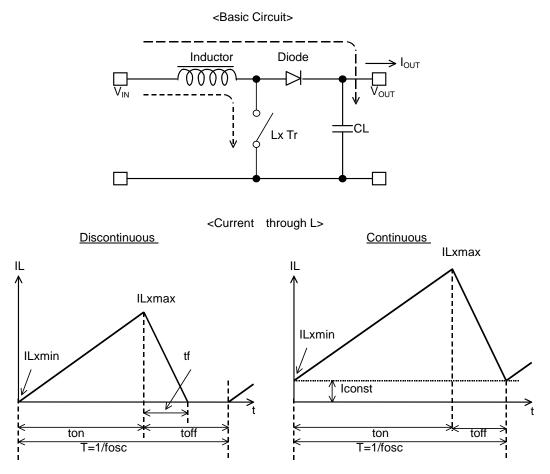
Set external components as close as possible to the IC and minimize the connection between the components and the IC. In particular, output capacitor should be connected to V_{OUT} pin with IC ground by the minimum connection, because this IC uses the V_{OUT} voltage as the main power supply, after start-up. Use capacitors with a capacity of 10μ F or more for V_{OUT} pin. We recommend you to set a ceramic capacitor (10μ F) between V_{IN} and ground.

The divider resistors should be placed as close as possible to the IC ground pin. V_{FB} line is recommended to use short line as well to avoid the influence of noise.

Please select the inductor value 10μ H in the case of $V_{OUT} \ge 2.5V$ and 6.8μ H in the case of $V_{OUT} < 2.5V$. Choose an inductor that has sufficiently small D.C. resistance and large allowable current and is hard to reach magnetic saturation. And if the value of inductance of an inductor is extremely small, the I_{LX} may exceed the absolute maximum rating at the maximum loading. Use an inductor with appropriate inductance. (Refer to next Output Current of Step-up Circuit and External Components)

*The performance of power circuit using those ICs extremely depends upon the peripheral circuits. Pay attention in the selection of the peripheral circuits. In particular, design the peripheral circuits in a way that the values such as voltage, current, and power of each component, PCB patterns and the IC do not exceed their respected rated values. (such as the voltage, current , and power)

OUTPUT CURRENT OF STEP-UP CIRCUIT AND EXTERNAL COMPONENTS



There are two modes, or discontinuous mode and continuous mode for the PWM step-up switching regulator depending on the continuous characteristic of inductor current. During on time of the transistor, when the voltage added on to the inductor is described as V_{IN} , the current is $V_{IN} \times t / L$.

Therefore, the electric power, PON, which is supplied with input side, can be described as in next formula.

$$P_{ON} = \int_{0}^{ton} V_{IN^2} \times t/L \ dt \ Formula 1$$

With the step-up circuit, electric power is supplied from power source also during off time. In this case, input current is described as $(V_{OUT} - V_{IN}) \times t / L$, therefore electric power, P_{OFF} is described as in next formula.

$$P_{\text{OFF}} = \int_{0}^{tf} V_{\text{IN}} \times (V_{\text{OUT}} - V_{\text{IN}})t/L \ dt \ ...$$
 Formula 2

In this formula, tf means the time of which the energy saved in the inductance is being emitted. Thus average electric power, P_{AV} is described as in the next formula.

$$P_{AV} = 1/(ton + toff) \times \{\int_{0}^{ton} V_{IN}^{2} \times t/L \ dt + \int_{0}^{tf} V_{IN} \times (V_{OUT} - V_{IN})t/L \ dt\} \ \cdots \ \text{Formula 3}$$

In PWM control, when tf = toff is true, the inductor current becomes continuous, then the operation of switching regulator becomes continuous mode. In the continuous mode, the deviation of the current is equal between on time and off time.

 $V_{IN} \times ton / L = (V_{OUT} - V_{IN}) \times toff / L$ Formula 4

Further, the electric power, PAV is equal to output electric power, $V_{OUT} \times I_{OUT}$, thus,

$$I_{OUT} = fosc \times V_{IN}^2 \times ton^2 / \{2 \times L (V_{OUT} - V_{IN})\} = V_{IN}^2 \times ton / (2 \times L \times V_{OUT}) \dots Formula 5$$

When I_{OUT} becomes more than $V_{IN} \times \text{ton} \times \text{toff} / (2 \times L \times (\text{ton + toff}))$, the current flows through the inductor, then the mode becomes continuous. The continuous current through the inductor is described as lconst, then,

 $I_{OUT} = fosc \times V_{IN}^2 \times ton^2 / (2 \times L \times (V_{OUT} - V_{IN})) + V_{IN} \times Iconst / V_{OUT} \cdots Formula 6$

In this moment, the peak current, ILxmax flowing through the inductor and the driver Tr. is described as follows:

ILxmax = Iconst + V_{IN} × ton / L ·····Formula 7

With the formula 4, 6 and ILxmax is

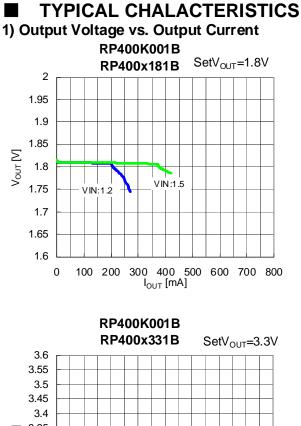
$$\begin{aligned} \text{ILxmax} &= V_{\text{OUT}} / V_{\text{IN}} \times I_{\text{OUT}} + V_{\text{IN}} \times \text{ton} / (2 \times L) \\ \text{However, ton} &= (1 - V_{\text{IN}} / V_{\text{OUT}}) / \text{fosc} \end{aligned}$$

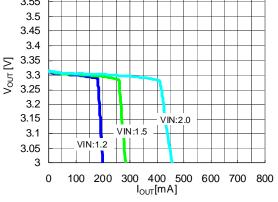
Therefore, peak current is more than I_{OUT}. Considering the value of ILxmax, the condition of input and output, and external components should be selected.

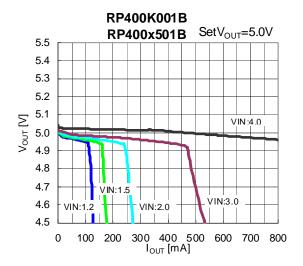
In the formula 7, peak current ILxmax at discontinuous mode can be calculated. Put lconst = 0 in the formula.

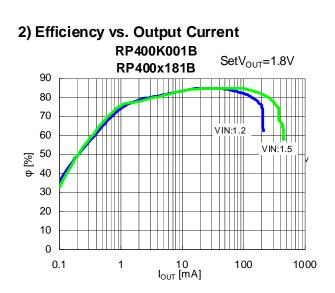
The explanation above is based on the ideal calculation, and the loss caused by Lx switch and external components is not included.

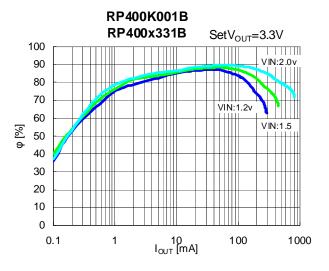
Please select the inductor and the diode with current peak to the standard (Formula 8).

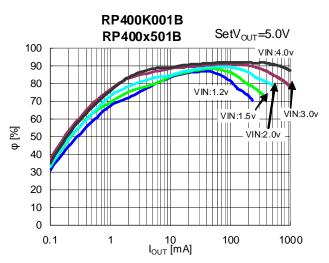


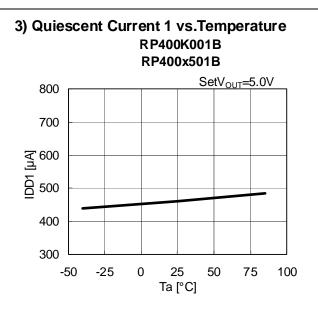


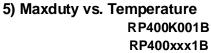


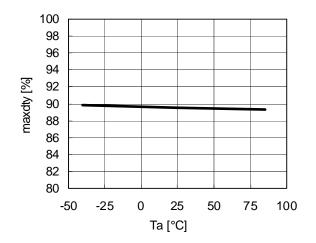




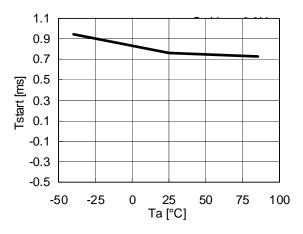


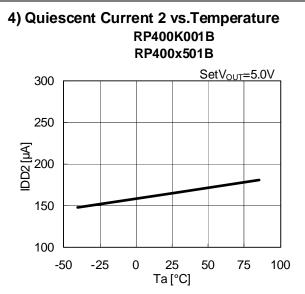




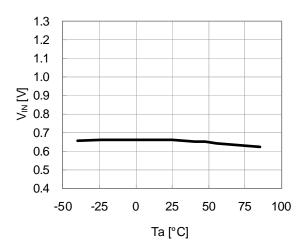


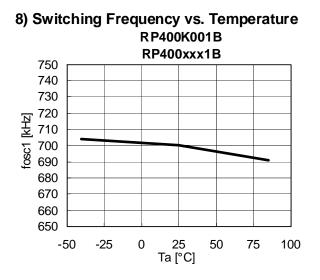




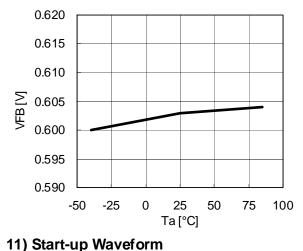




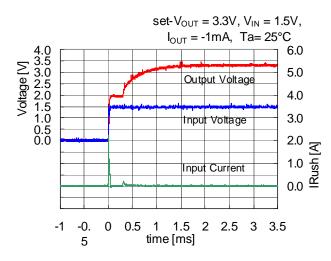


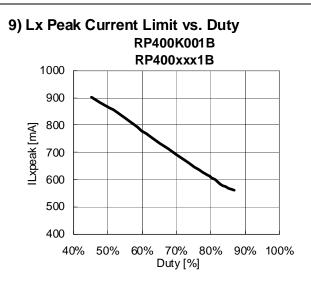


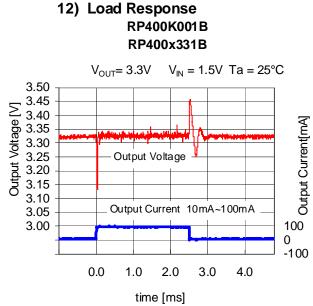
10) Feedback Voltage vs. Temperature RP400x001B

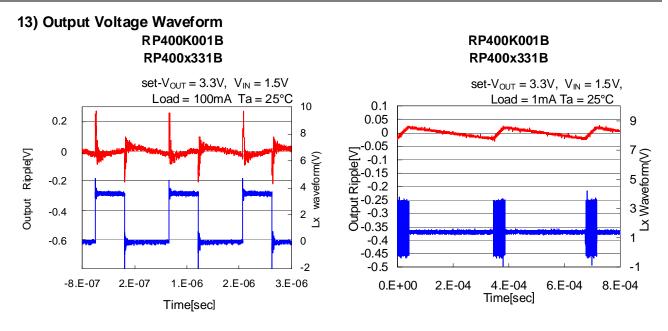


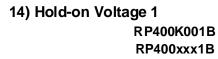
RP400K001B RP400x331B

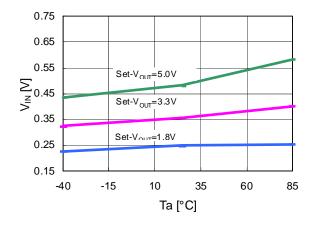












- 1. The products and the product specifications described in this document are subject to change or discontinuation of production without notice for reasons such as improvement. Therefore, before deciding to use the products, please refer to Ricoh sales representatives for the latest information thereon.
- 2. The materials in this document may not be copied or otherwise reproduced in whole or in part without prior written consent of Ricoh.
- 3. Please be sure to take any necessary formalities under relevant laws or regulations before exporting or otherwise taking out of your country the products or the technical information described herein.
- 4. The technical information described in this document shows typical characteristics of and example application circuits for the products. The release of such information is not to be construed as a warranty of or a grant of license under Ricoh's or any third party's intellectual property rights or any other rights.
- 5. The products listed in this document are intended and designed for use as general electronic components in standard applications (office equipment, telecommunication equipment, measuring instruments, consumer electronic products, amusement equipment etc.). Those customers intending to use a product in an application requiring extreme quality and reliability, for example, in a highly specific application where the failure or misoperation of the product could result in human injury or death (aircraft, spacevehicle, nuclear reactor control system, traffic control system, automotive and transportation equipment, combustion equipment, safety devices, life support system etc.) should first contact us.
- 6. We are making our continuous effort to improve the quality and reliability of our products, but semiconductor products are likely to fail with certain probability. In order to prevent any injury to persons or damages to property resulting from such failure, customers should be careful enough to incorporate safety measures in their design, such as redundancy feature, fire containment feature and fail-safe feature. We do not assume any liability or responsibility for any loss or damage arising from misuse or inappropriate use of the products.
- 7. Anti-radiation design is not implemented in the products described in this document.
- 8. The X-ray exposure can influence functions and characteristics of the products. Confirm the product functions and characteristics in the evaluation stage.
- 9. WLCSP products should be used in light shielded environments. The light exposure can influence functions and characteristics of the products under operation or storage.
- 10. There can be variation in the marking when different AOI (Automated Optical Inspection) equipment is used. In the case of recognizing the marking characteristic with AOI, please contact Ricoh sales or our distributor before attempting to use AOI.
- 11. Please contact Ricoh sales representatives should you have any questions or comments concerning the products or the technical information.



Ricoh is committed to reducing the environmental loading materials in electrical devices with a view to contributing to the protection of human health and the environment. Ricoh has been providing RoHS compliant products since April 1, 2006 and Halogen-free products since April 1, 2012.

RICOH RICOH ELECTRONIC DEVICES CO., LTD.

https://www.e-devices.ricoh.co.jp/en/

Sales & Support Offices

Ricoh Electronic Devices Co., Ltd.

Shin-Yokohama Office (International Sales) 2-3, Shin-Yokohama 3-chome, Kohoku-ku, Yokohama-shi, Kanagawa, 222-8530, Japan Phone: +81-50-3814-7687 Fax: +81-45-474-0074

Ricoh Americas Holdings, Inc way, Suite 200 Campbell, CA 95008, U.S.A. 675 Campbell Technology Parl Phone: +1-408-610-3105

Ricoh Europe (Netherlands) B.V. Semiconductor Support Centre

Prof. W.H. Keesomlaan 1, 1183 DJ Amstelveen, The Netherlands Phone: +31-20-5474-309

Ricoh International B.V. - German Branch Semiconductor Sales and Support Centre Oberrather Strasse 6, 40472 Düsseldorf, Germany Phone: +49-211-6546-0

Ricoh Electronic Devices Korea Co., Ltd. 3F, Haesung Bldg, 504, Teheran-ro, Gangnam-gu, Seoul, 135-725, Korea Phone: +82-2-2135-5700 Fax: +82-2-2051-5713

Ricoh Electronic Devices Shanghai Co., Ltd. Room 403, No.2 Building, No.690 Bibo Road, Pu Dong New District, Shanghai 201203, People's Republic of China

Phone: +86-21-5027-3200 Fax: +86-21-5027-3299 Ricoh Electronic Devices Shanghai Co., Ltd.

Shenzhen Branch 1205, Block D(Jinlong Building), Kingkey 100, Hongbao Road, Luohu District, Shenzhen, China Phone: +86-755-8348-7600 Ext 225

Ricoh Electronic Devices Co., Ltd.

 Taipei office

 Room 109, 10F-1, No.51, Hengyang Rd., Taipei City, Taiwan (R.O.C.)

 Phone: +886-2-2313-1621/1622

 Fax: +886-2-2313-1621/1622